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# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









### 1. Global joint venture starts operations as WeEn Semiconductors

Dear customer.

As from November 9th, 2015 NXP Semiconductors N.V. and Beijing JianGuang Asset Management Co. Ltd established Bipolar Power joint venture (JV), **WeEn Semiconductors**, which will be used in future Bipolar Power documents together with new contact details.

In this document where the previous NXP references remain, please use the new links as shown below.

WWW - For www.nxp.com use www.ween-semi.com

Email - For salesaddresses@nxp.com use salesaddresses@ween-semi.com

For the copyright notice at the bottom of each page (or elsewhere in the document, depending on the version) "© NXP Semiconductors N.V. {year}. All rights reserved" becomes "© WeEn Semiconductors Co., Ltd. {year}. All rights reserved"

If you have any questions related to this document, please contact our nearest sales office via e-mail or phone (details via <a href="mailto:salesaddresses@ween-semi.com">salesaddresses@ween-semi.com</a>).

Thank you for your cooperation and understanding,

WeEn Semiconductors



Thyristors BT145 series

### **GENERAL DESCRIPTION**

# Glass passivated thyristors in a plastic envelope, intended for use in applications requiring high bidirectional blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.

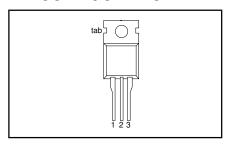
### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	MAX.	MAX.	MAX.	UNIT
V <sub>DRM</sub> ,	BT145- Repetitive peak off-state voltages	<b>500R</b> 500	<b>600R</b> 600	<b>800R</b> 800	V
V RRM I <sub>T(AV)</sub> I <sub>T(RMS)</sub> I <sub>TSM</sub>	Average on-state current RMS on-state current Non-repetitive peak on-state current	16 25 300	16 25 300	16 25 300	A A A

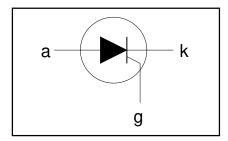
### **PINNING - TO220AB**

PIN	DESCRIPTION			
1	cathode			
2	anode			
3	gate			
tab	anode			

### **PIN CONFIGURATION**



### **SYMBOL**



### **LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.		MAX.		UNIT
V <sub>DRM</sub> , V <sub>RRM</sub>	Repetitive peak off-state voltages		-	<b>-500R</b> 500 <sup>1</sup>	<b>-600R</b> 600 <sup>1</sup>	<b>-800R</b> 800	>
$\begin{vmatrix} I_{T(AV)} \\ I_{T(RMS)} \\ I_{TSM} \end{vmatrix}$	Average on-state current RMS on-state current Non-repetitive peak on-state current	half sine wave; $T_{mb} \le 101  ^{\circ}\text{C}$ all conduction angles half sine wave; $T_{j} = 25  ^{\circ}\text{C}$ prior to surge	-		16 25		A A
	on state surrent	t = 10 ms t = 8.3 ms	-		300 330		A A
l <sup>2</sup> t	I <sup>2</sup> t for fusing	t = 10 ms	-		450		A <sup>2</sup> s
dl <sub>⊤</sub> /dt	Repetitive rate of rise of on-state current after triggering	$I_{TM} = 50 \text{ A}; I_G = 0.2 \text{ A}; \\ dI_G/dt = 0.2 \text{ A}/\mu\text{s}$	-		200		A/μs
I <sub>GM</sub>	Peak gate current		-		5		Α
$V_{\rm GM}$	Peak gate voltage		-		5		V
V <sub>RGM</sub>	Peak reverse gate voltage		-		5		l w l
P <sub>GM</sub>	Peak gate power Average gate power	over any 20 ms period	-		20 0.5		
$ \begin{array}{c} P_{G(AV)} \\ T_{stg} \\ T_{j} \end{array} $	Storage temperature Operating junction temperature	Tover any 20 ms penou	-40 -		150 125		ο̈́ο

October 1997 1 Rev 1.200

<sup>1</sup> Although not recommended, off-state voltages up to 800V may be applied without damage, but the thyristor may switch to the on-state. The rate of rise of current should not exceed 15  $A/\mu s$ .

Philips Semiconductors Product specification

Thyristors BT145 series

## **THERMAL RESISTANCES**

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R <sub>th j-mb</sub>	Thermal resistance		-	-	1.0	K/W
R <sub>th i-a</sub>	junction to mounting base Thermal resistance junction to ambient	in free air	-	60	-	K/W

### STATIC CHARACTERISTICS

 $T_j = 25$  °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I <sub>GT</sub>	Gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}$	-	5	35	mA
l I	Latching current	$V_D = 12 \text{ V}; I_{GT} = 0.1 \text{ A}$	-	25	80	mA
I <sub>H</sub>	Holding current	$V_D = 12 \text{ V}; I_{GT} = 0.1 \text{ A}$	-	20	60	mA
ĺΫ́	On-state voltage	$I_T = 30 \text{ A}$	-	1.1	1.5	V
V <sub>GT</sub>	Gate trigger voltage	$\dot{V}_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}$	-	0.6	1.0	V
<u> </u>		$V_D = V_{DBM(mov)}$ : $I_T = 0.1 \text{ A}$ : $T_1 = 125 ^{\circ}\text{C}$	0.25	0.4	-	V
$I_D, I_R$	Off-state leakage current	$V_D = V_{DRM(max)}^{DRM(max)}; V_R = V_{RRM(max)}; T_j = 125 °C$	-	0.2	1.0	mA

### **DYNAMIC CHARACTERISTICS**

T<sub>i</sub> = 25 °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
dV <sub>D</sub> /dt	Critical rate of rise of off-state voltage	$V_{DM} = 67\% V_{DRM(max)}; T_j = 125 °C;$ exponential waveform; gate open circuit	200	500	-	V/μs
t <sub>gt</sub>	Gate controlled turn-on time	$I_{TM} = 40 \text{ A}; V_D = V_{DRM(max)}; I_G = 0.1 \text{ A};$ $dI_G/dt = 5 \text{ A}/\mu\text{s}$	-	2	-	μs
t <sub>q</sub>	Circuit commutated turn-off time	$V_D^{\rm o} = 67\% \ V_{\rm DRM(max)}^{\rm r}; \ T_{\rm i} = 125 \ ^{\circ}{\rm C}; \ I_{\rm TM} = 50 \ {\rm A}; \ V_{\rm R} = 25 \ {\rm V}; \ {\rm d}I_{\rm TM}/{\rm d}t = 30 \ {\rm A}/\mu {\rm s};$	-	70	-	μs
		$dV_D/dt = 50 V/\mu s$				

Philips Semiconductors Product specification

Thyristors BT145 series

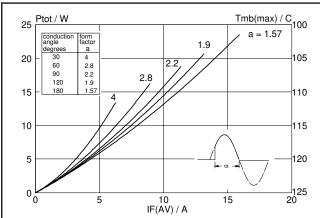


Fig.1. Maximum on-state dissipation,  $P_{tot}$ , versus average on-state current,  $I_{T(AV)}$ , where a = form factor =  $I_{T(RMS)}/I_{T(AV)}$ .

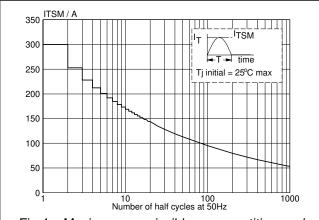


Fig.4. Maximum permissible non-repetitive peak on-state current  $I_{TSM}$ , versus number of cycles, for sinusoidal currents, f = 50 Hz.

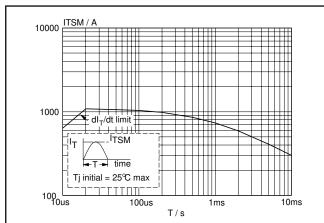


Fig.2. Maximum permissible non-repetitive peak on-state current  $I_{TSM}$ , versus pulse width  $t_p$ , for sinusoidal currents,  $t_p \le 10$ ms.

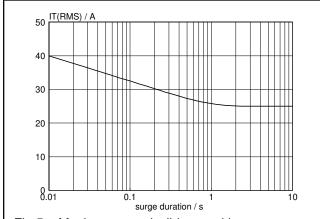


Fig.5. Maximum permissible repetitive rms on-state current  $I_{T(RMS)}$ , versus surge duration, for sinusoidal currents, f = 50 Hz;  $T_{mb} \le 101$  °C.

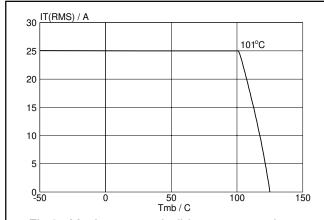
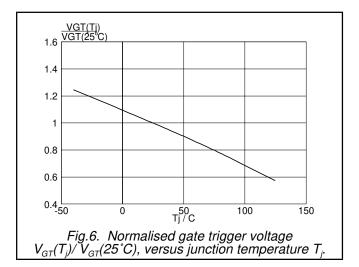
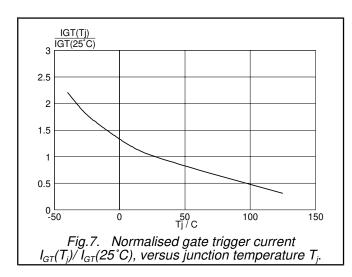


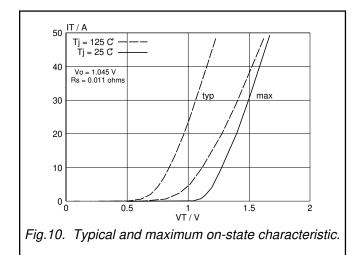
Fig.3. Maximum permissible rms current  $I_{T(RMS)}$ , versus mounting base temperature  $T_{mb}$ .

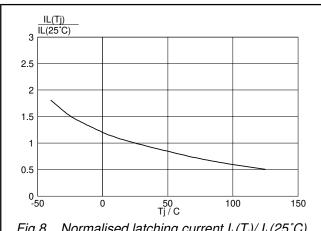


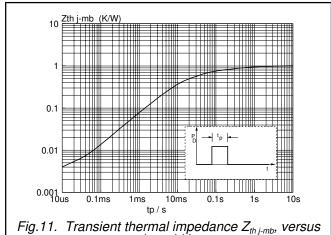
Philips Semiconductors Product specification

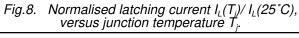
**Thyristors** BT145 series



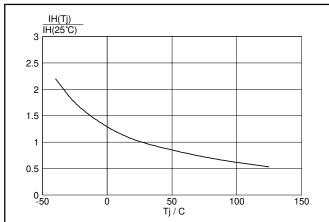








pulse width t<sub>n</sub>.



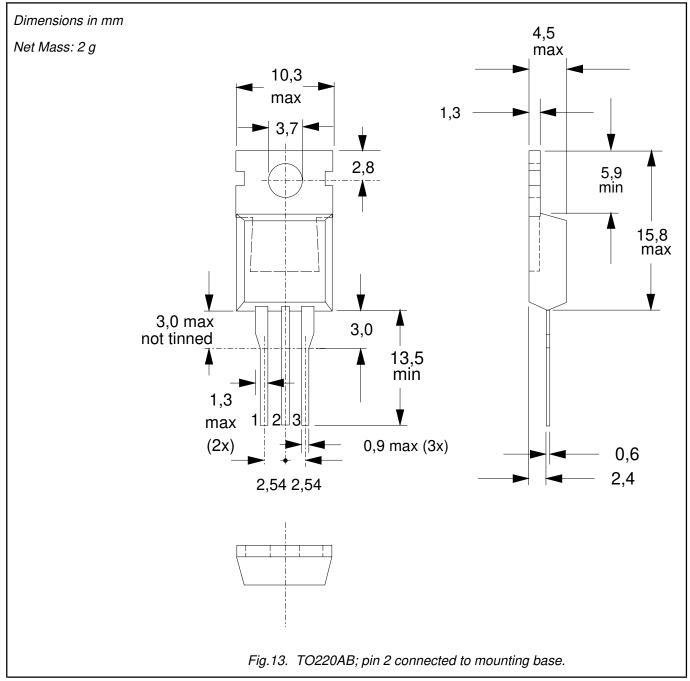
10000 dVD/dt (V/us) 1000 100 50 100 Tj / C

Fig.9. Normalised holding current  $I_H(T_i)/I_H(25^{\circ}C)$ , versus junction temperature  $T_i$ .

Fig.12. Typical, critical rate of rise of off-state voltage, dV<sub>D</sub>/dt versus junction temperature T<sub>j</sub>.

BT145 series **Thyristors** 

### **MECHANICAL DATA**



- Notes
  1. Refer to mounting instructions for TO220 envelopes.
  2. Epoxy meets UL94 V0 at 1/8".

Philips Semiconductors Product specification

Thyristors BT145 series

### **DEFINITIONS**

Data sheet status						
This data sheet contains target or goal specifications for product development.						
This data sheet contains preliminary data; supplementary data may be published later.						
This data sheet contains final product specifications.						

### Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

### **Application information**

Where application information is given, it is advisory and does not form part of the specification.

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